### GaN on SiC HEMT Pulsed Power Transistor 125W Peak, 1200-1400 MHz, 300µs Pulse, 10% Duty

#### Features

- GaN on SiC Depletion-Mode Transistor Technology
- Internally Matched
- Common-Source Configuration
- Broadband Class AB Operation
- RoHS\* Compliant and 260 °C Reflow Compatible
- +50 V Typical Operation
- MTTF = 600 years (T<sub>J</sub> < 200 °C)</li>

#### Applications

• L-Band pulsed radar

#### Description

The MAGX-001214-125L00 is a gold metalized matched Gallium Nitride (GaN) on Silicon Carbide RF power transistor optimized for pulsed L-Band radar applications. Using state of the art wafer fabrication processes, these high performance transistors provide high gain, efficiency, bandwidth, ruggedness over a wide bandwidth for today's demanding application needs. High breakdown voltages allow for reliable and stable operation in extreme mismatched load conditions unparalleled with older semiconductor technologies.



#### **Ordering Information**

Part Number	Description
MAGX-001214-125L00	125W GaN Power Transistor
MAGX-001214-SB0PPR	Evaluation Test Fixture

Freq (MHz)	P <sub>IN</sub> (W)	Gain (dB)	І <sub>D</sub> (А)	Eff. (%)	RL (dB)	Droop (dB)	VSWR-S (5:1)	VSWR-T (10:1)
1200	1.8	18.3	4.0	62.5	-9.0	0.4	S	Р
1250	1.9	18.1	4.2	59.0	-11.6	0.6	S	Р
1300	2.0	18.0	4.4	56.5	-16.0	0.6	S	Р
1350	1.9	18.1	4.3	57.7	-19.0	0.5	S	Р
1400	1.8	18.4	3.9	62.9	-14.5	0.3	S	Р

### Typical RF Performance under Standard Operating Conditions, Pout = 125 W (Peak)

\* Restrictions on Hazardous Substances, European Union Directive 2002/95/EC.

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### Electrical Specifications: Freq. = 1200 - 1400 MHz, T<sub>A</sub> = 25°C

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Units
<b>RF</b> Functional Tests						
Peak Input Power		P <sub>IN</sub>	-	1.9	2.4	W
Power Gain		G <sub>P</sub>	17.2	18.1	-	dB
Drain Efficiency		$\eta_{D}$	54	59.8	-	%
Load Mismatch Stability		VSWR-S	5:1	-	-	-
Load Mismatch Tolerance		VSWR-T	10:1	-	-	-

#### **Electrical Characteristics:** T<sub>A</sub> = 25°C

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Units
DC Characteristics						
Drain-Source Leakage Current	$V_{GS}$ = -8 V, $V_{DS}$ = 175 V	I <sub>DS</sub>	-	0.2	6	mA
Gate Threshold Voltage	$V_{DS}$ = 5 V, I <sub>D</sub> = 15 mA	V <sub>GS (TH)</sub>	-5	-3.8	-2	V
Forward Transconductance	$V_{DS} = 5 V, I_D = 3.5 mA$	G <sub>M</sub>	2.5	3.6	-	S
Dynamic Characteristics						
Input Capacitance	Not applicable - Input matched	CISS	N/A	N/A	N/A	pF
Output Capacitance	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = -8 V,	C <sub>OSS</sub>	-	11	-	pF
Reverse Transfer Capacitance	Freq. = 1 MHz	C <sub>RSS</sub>	-	1.1	-	pF



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## Absolute Maximum Ratings<sup>1,2,3</sup>

Parameter	Limit
Drain Voltage (V <sub>DD</sub> )	+65 V
Gate Voltage (V <sub>GG</sub> )	-8 to -2 V
Drain Current (I <sub>DD</sub> )	6.0 A
Input Power <sup>4</sup> (P <sub>IN</sub> )	P <sub>IN</sub> (nominal) + 3 dB
Operating Junction Temperature <sup>5</sup>	250 °C
Peak Pulsed Power Dissipation at 85 °C	175 W
Operating Temperature Range	-40 to +95 °C
Storage Temperature Range	-65 to +150 °C
ESD Maximum - Machine Model (MM)	50 V
ESD Maximum - Human Body Model (HBM)	250 V

1. Exceeding any one or combination of these limits may cause permanent damage to this device.

2. MACOM does not recommend sustained operation near these survivability limits.

3. For saturated performance it is recommended that the sum of ( $3 * V_{DD} + |V_{GG}|$ ) < 175 V.

4. Input Power Limit is +3 dB over nominal drive required to achieve Pout = 125 W.

5. Operating junction temperature is measured with infrared (IR) microscope. Junction temperature directly affects a device's MTTF and should be kept as low as possible to maximize lifetime.

• MTTF =  $5.3 \times 10^6$  hours (T<sub>J</sub> < 200 °C)

• MTTF =  $6.8 \times 10^4$  hours (T<sub>J</sub> < 250 °C)

#### **Thermal Characteristics**

Parameter	Test Conditions	Symbol	Typical	Units
Thermal Resistance	$T_{C}$ = 70 °C, $V_{DD}$ = 50 V, $I_{DQ}$ = 100 mA, $P_{OUT}$ = 125 W, Pulse Width = 300 µs, Duty Cycle = 10%	$\Theta_{\text{JC}}$	1.0	°C/W

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#### **Test Fixture Assembly**



Contact MACOM for additional circuit information.

Freq. (MHz)	Z <sub>IF</sub> (Ω)	Z <sub>OF</sub> (Ω)
1200	6.6 - j7.1	8.0 + j1.9
1250	6.6 - j6.9	7.4 + j1.3
1300	6.6 - j6.7	6.6 + j1.3
1350	6.7 - j6.7	6.1 + j1.6
1400	6.7 - j6.7	5.7 + j2.2



### **Correct Device Sequencing**

#### **Turning the device ON**

- 1. Set  $V_{GS}$  to the pinch-off ( $V_P$ ), typically -5 V.
- 2. Turn on  $V_{DS}$  to nominal voltage (50 V).
- 3. Increase  $V_{\text{GS}}$  until the  $I_{\text{DS}}$  current is reached.
- 4. Apply RF power to desired level.

#### Turning the device OFF

- 1. Turn the RF power off.
- 2. Decrease  $V_{GS}$  down to  $V_{P.}$
- 3. Decrease  $V_{\text{DS}}$  down to 0 V.
- 4. Turn off  $V_{GS}$

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RF Power Transfer Curve (Drain Efficiency Vs. Output Power)





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### **Outline Drawing<sup>†</sup>**



† Reference Application Note AN3025 for mounting/soldering recommendations. Meets JEDEC moisture sensitivity level 1 requirements. Plating is Ni/Au.

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